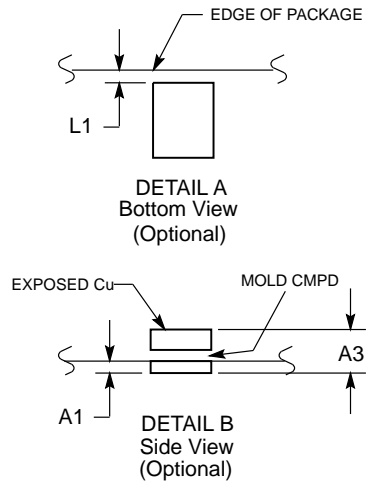


# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS



L2 | 0.40 | 0.50

### GENERIC MARKING DIAGRAM\*



X = Specific Device Code  
M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb iFree indicator, "G" or microdot " ", may or may not be present.



iFree strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.